

The MAX481, MAX483, MAX485, MAX487–MAX491, and MAX1487 are low-power transceivers for RS-485 and RS-422 communication. Each part contains one driver and one receiver. The MAX483, MAX487, MAX488, and MAX489 feature reduced slew-rate drivers that minimize EMI and reduce reflections caused by improperly terminated cables, thus allowing error-free data transmission up to 250kbps. The driver slew rates of the MAX481, MAX485, MAX490, MAX491, and MAX1487 are not limited, allowing them to transmit up to 2.5Mbps.

These transceivers draw between 120µA and 500µA of supply current when unloaded or fully loaded with disabled drivers. Additionally, the MAX481, MAX483, and MAX487 have a low-current shutdown mode in which they consume only 0.1µA. All parts operate from a single 5V supply.

Drivers are short-circuit current limited and are protected against excessive power dissipation by thermal shutdown circuitry that places the driver outputs into a high-impedance state. The receiver input has a fail-safe feature that guarantees a logic-high output if the input is open circuit.

The MAX487 and MAX1487 feature quarter-unit-load receiver input impedance, allowing up to 128 MAX487/MAX1487 transceivers on the bus. Full-duplex communications are obtained using the MAX488–MAX491, while the MAX481, MAX483, MAX485, MAX487, and MAX1487 are designed for half-duplex applications.

Applications

Low-Power RS-485 Transceivers
 Low-Power RS-422 Transceivers
 Level Translators
 Transceivers for EMI-Sensitive Applications
 Industrial-Control Local Area Networks

◆ For Fault-Tolerant Applications

MAX3430: ±80V Fault-Protected, Fail-Safe, 1/4 Unit Load, +3.3V, RS-485 Transceiver
MAX3440E–MAX3444E: ±15kV ESD-Protected, ±60V Fault-Protected, 10Mbps, Fail-Safe, RS-485/J1708 Transceivers

◆ For Space-Constrained Applications

MAX3460–MAX3464: +5V, Fail-Safe, 20Mbps, Profibus RS-485/RS-422 Transceivers
MAX3362: +3.3V, High-Speed, RS-485/RS-422 Transceiver in a SOT23 Package
MAX3280E–MAX3284E: ±15kV ESD-Protected, 52Mbps, +3V to +5.5V, SOT23, RS-485/RS-422, True Fail-Safe Receivers
MAX3293/MAX3294/MAX3295: 20Mbps, +3.3V, SOT23, RS-855/RS-422 Transmitters

◆ For Multiple Transceiver Applications

MAX3030E–MAX3033E: ±15kV ESD-Protected, +3.3V, Quad RS-422 Transmitters

◆ For Fail-Safe Applications

MAX3080–MAX3089: Fail-Safe, High-Speed (10Mbps), Slew-Rate-Limited RS-485/RS-422 Transceivers

◆ For Low-Voltage Applications

MAX3483E/MAX3485E/MAX3486E/MAX3488E/MAX3490E/MAX3491E: +3.3V Powered, ±15kV ESD-Protected, 12Mbps, Slew-Rate-Limited, True RS-485/RS-422 Transceivers

Ordering Information appears at end of data sheet.

Selection Table

PART NUMBER	HALF/FULL DUPLEX	DATA RATE (Mbps)	SLEW-RATE LIMITED	LOW-POWER SHUTDOWN	RECEIVER/ DRIVER ENABLE	QUIESCENT CURRENT (µA)	NUMBER OF TRANSMITTERS ON BUS	PIN COUNT
MAX481	Half	2.5	No	Yes	Yes	300	32	8
MAX483	Half	0.25	Yes	Yes	Yes	120	32	8
MAX485	Half	2.5	No	No	Yes	300	32	8
MAX487	Half	0.25	Yes	Yes	Yes	120	128	8
MAX488	Full	0.25	Yes	No	No	120	32	8
MAX489	Full	0.25	Yes	No	Yes	120	32	14
MAX490	Full	2.5	No	No	No	300	32	8
MAX491	Full	2.5	No	No	Yes	300	32	14
MAX1487	Half	2.5	No	No	Yes	230	128	8

ABSOLUTE MAXIMUM RATINGS

Supply Voltage (V_{CC}) 12V
 Control Input Voltage ($\overline{RE}$, DE) -0.5V to ($V_{CC} + 0.5V$)
 Driver Input Voltage (DI) -0.5V to ($V_{CC} + 0.5V$)
 Driver Output Voltage (A, B) -8V to +12.5V
 Receiver Input Voltage (A, B) -8V to +12.5V
 Receiver Output Voltage (RO) -0.5V to ($V_{CC} + 0.5V$)
 Continuous Power Dissipation ($T_A = +70^\circ\text{C}$)
 8-Pin Plastic DIP (derate 9.09mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$) 727mW
 14-Pin Plastic DIP (derate 10.00mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$) 800mW
 8-Pin SO (derate 5.88mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$) 471mW

14-Pin SO (derate 8.33mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$) 667mW
 8-Pin μMAX (derate 4.1mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$) 830mW
 8-Pin Cerdip (derate 8.00mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$) 640mW
 14-Pin Cerdip (derate 9.09mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$) 727mW
 Operating Temperature Ranges
 MAX4_ _C_ /MAX1487C_ A 0°C to $+70^\circ\text{C}$
 MAX4_ _E_ /MAX1487E_ A -40°C to $+85^\circ\text{C}$
 MAX4_ _MJ_ /MAX1487MJA -55°C to $+125^\circ\text{C}$
 Storage Temperature Range -65°C to $+160^\circ\text{C}$
 Lead Temperature (soldering, 10sec) $+300^\circ\text{C}$

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

($V_{CC} = 5V \pm 5\%$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Differential Driver Output (no load)	V_{OD1}					5	V
Differential Driver Output (with load)	V_{OD2}	$R = 50\Omega$ (RS-422)		2			V
		$R = 27\Omega$ (RS-485), Figure 4		1.5		5	
Change in Magnitude of Driver Differential Output Voltage for Complementary Output States	ΔV_{OD}	$R = 27\Omega$ or 50Ω , Figure 4				0.2	V
Driver Common-Mode Output Voltage	V_{OC}	$R = 27\Omega$ or 50Ω , Figure 4				3	V
Change in Magnitude of Driver Common-Mode Output Voltage for Complementary Output States	ΔV_{OD}	$R = 27\Omega$ or 50Ω , Figure 4				0.2	V
Input High Voltage	V_{IH}	DE, DI, $\overline{RE}$		2.0			V
Input Low Voltage	V_{IL}	DE, DI, $\overline{RE}$				0.8	V
Input Current	I_{IN1}	DE, DI, $\overline{RE}$				± 2	μA
Input Current (A, B)	I_{IN2}	DE = 0V; $V_{CC} = 0V$ or $5.25V$, all devices except MAX487/MAX1487	$V_{IN} = 12V$			1.0	mA
			$V_{IN} = -7V$			-0.8	
		MAX487/MAX1487, DE = 0V, $V_{CC} = 0V$ or $5.25V$	$V_{IN} = 12V$			0.25	mA
			$V_{IN} = -7V$			-0.2	
Receiver Differential Threshold Voltage	V_{TH}	$-7V \leq V_{CM} \leq 12V$		-0.2		0.2	V
Receiver Input Hysteresis	ΔV_{TH}	$V_{CM} = 0V$			70		mV
Receiver Output High Voltage	V_{OH}	$I_O = -4mA$, $V_{ID} = 200mV$		3.5			V
Receiver Output Low Voltage	V_{OL}	$I_O = 4mA$, $V_{ID} = -200mV$				0.4	V
Three-State (high impedance) Output Current at Receiver	I_{OZR}	$0.4V \leq V_O \leq 2.4V$				± 1	μA
Receiver Input Resistance	R_{IN}	$-7V \leq V_{CM} \leq 12V$, all devices except MAX487/MAX1487		12			$k\Omega$
		$-7V \leq V_{CM} \leq 12V$, MAX487/MAX1487		48			$k\Omega$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
No-Load Supply Current (Note 3)	I _{CC}	MAX488/MAX489, DE, DI, RE = 0V or V _{CC}		120	250	μA
		MAX490/MAX491, DE, DI, RE = 0V or V _{CC}		300	500	
		MAX481/MAX485, RE = 0V or V _{CC}	DE = V _{CC}	500	900	
			DE = 0V	300	500	
		MAX1487, RE = 0V or V _{CC}	DE = V _{CC}	300	500	
			DE = 0V	230	400	
		MAX483/MAX487, RE = 0V or V _{CC}	DE = 5V MAX483	350	650	
			DE = 0V MAX487	250	400	
Supply Current in Shutdown	I _{SHDN}	MAX481/483/487, DE = 0V, RE = V _{CC}		0.1	10	μA
Driver Short-Circuit Current, V _O = High	I _{OSD1}	-7V ≤ V _O ≤ 12V (Note 4)	35		250	mA
Driver Short-Circuit Current, V _O = Low	I _{OSD2}	-7V ≤ V _O ≤ 12V (Note 4)	35		250	mA
Receiver Short-Circuit Current	I _{OSR}	0V ≤ V _O ≤ V _{CC}	7		95	mA

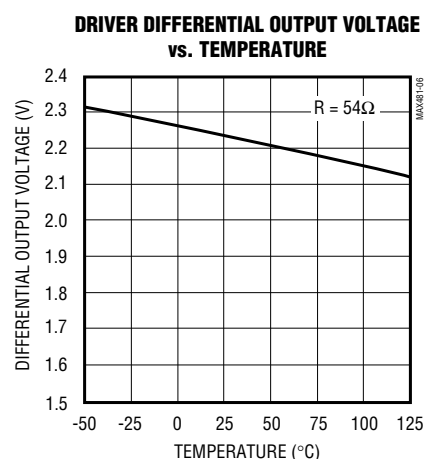
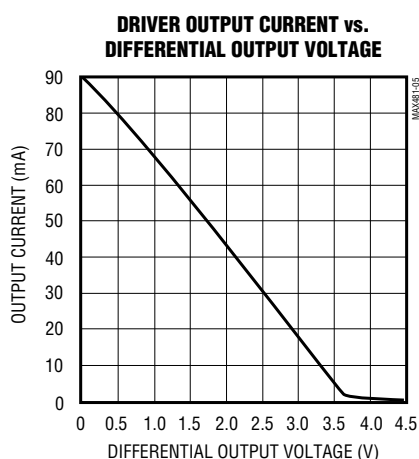
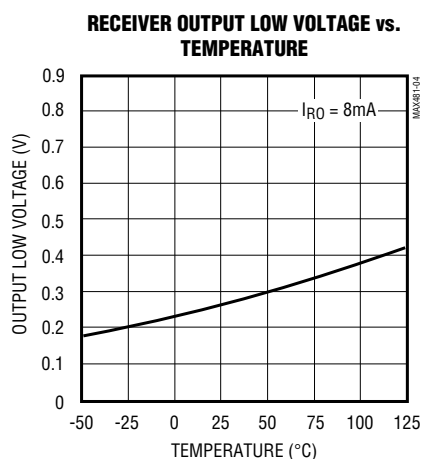
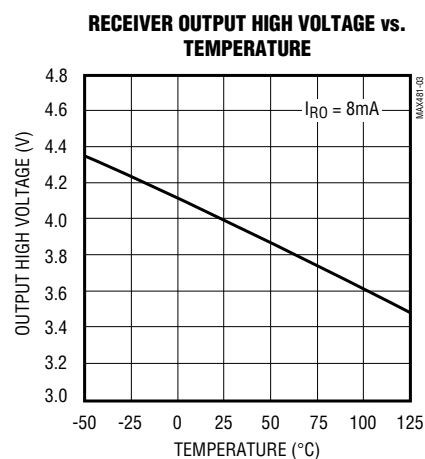
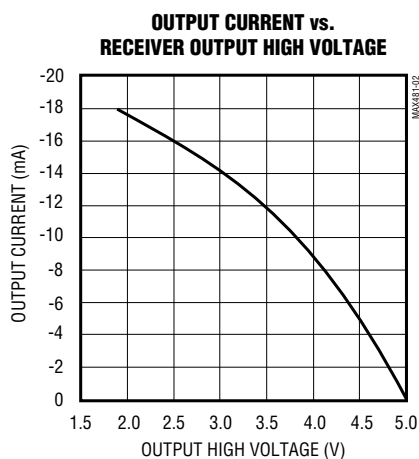
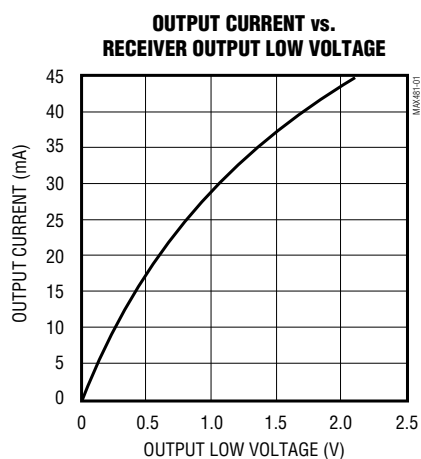
PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Driver Input to Output	tPLH	Figures 6 and 8, RDIFF = 54Ω, CL1 = CL2 = 100pF		10	30	60	ns
	tPHL			10	30	60	
Driver Output Skew to Output	tSKEW	Figures 6 and 8, RDIFF = 54Ω, CL1 = CL2 = 100pF			5	10	ns
Driver Rise or Fall Time	tR, tF	Figures 6 and 8, RDIFF = 54Ω, CL1 = CL2 = 100pF	MAX481, MAX485, MAX1487	3	15	40	ns
			MAX490C/E, MAX491C/E	5	15	25	
			MAX490M, MAX491M	3	15	40	
Driver Enable to Output High	tZH	Figures 7 and 9, CL = 100pF, S2 closed			40	70	ns
Driver Enable to Output Low	tZL	Figures 7 and 9, CL = 100pF, S1 closed			40	70	ns
Driver Disable Time from Low	tLZ	Figures 7 and 9, CL = 15pF, S1 closed			40	70	ns
Driver Disable Time from High	tHZ	Figures 7 and 9, CL = 15pF, S2 closed			40	70	ns
Receiver Input to Output	tPLH, tPHL	Figures 6 and 10, RDIFF = 54Ω, CL1 = CL2 = 100pF	MAX481, MAX485, MAX1487	20	90	200	ns
			MAX490C/E, MAX491C/E	20	90	150	
			MAX490M, MAX491M	20	90	200	
tPLH - tPHL Differential Receiver Skew	tSKD	Figures 6 and 10, RDIFF = 54Ω, CL1 = CL2 = 100pF			13		ns
Receiver Enable to Output Low	tZL	Figures 5 and 11, CRL = 15pF, S1 closed			20	50	ns
Receiver Enable to Output High	tZH	Figures 5 and 11, CRL = 15pF, S2 closed			20	50	ns
Receiver Disable Time from Low	tLZ	Figures 5 and 11, CRL = 15pF, S1 closed			20	50	ns
Receiver Disable Time from High	tHZ	Figures 5 and 11, CRL = 15pF, S2 closed			20	50	ns
Maximum Data Rate	fMAX			2.5			Mbps
Time to Shutdown	tSHDN	MAX481 (Note 5)		50	200	600	ns

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Driver Enable from Shutdown to Output High (MAX481)	t _{ZH} (SHDN)	Figures 7 and 9, C _L = 100pF, S2 closed		40	100	ns
Driver Enable from Shutdown to Output Low (MAX481)	t _{ZL} (SHDN)	Figures 7 and 9, C _L = 100pF, S1 closed		40	100	ns
Receiver Enable from Shutdown to Output High (MAX481)	t _{ZH} (SHDN)	Figures 5 and 11, C _L = 15pF, S2 closed, A - B = 2V		300	1000	ns
Receiver Enable from Shutdown to Output Low (MAX481)	t _{ZL} (SHDN)	Figures 5 and 11, C _L = 15pF, S1 closed, B - A = 2V		300	1000	ns

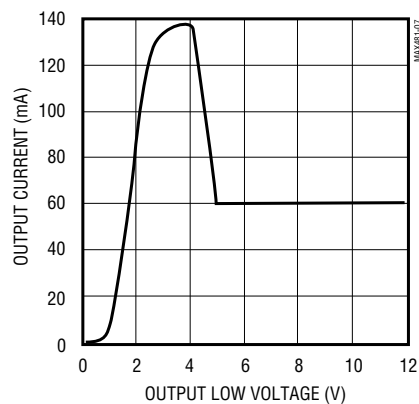
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Driver Input to Output	t _{PLH}	Figures 6 and 8, R _{DIFF} = 54Ω, C _{L1} = C _{L2} = 100pF	250	800	2000	ns
	t _{PHL}		250	800	2000	
Driver Output Skew to Output	t _{SKEW}	Figures 6 and 8, R _{DIFF} = 54Ω, C _{L1} = C _{L2} = 100pF		100	800	ns
Driver Rise or Fall Time	t _R , t _F	Figures 6 and 8, R _{DIFF} = 54Ω, C _{L1} = C _{L2} = 100pF	250		2000	ns
Driver Enable to Output High	t _{ZH}	Figures 7 and 9, C _L = 100pF, S2 closed	250		2000	ns
Driver Enable to Output Low	t _{ZL}	Figures 7 and 9, C _L = 100pF, S1 closed	250		2000	ns
Driver Disable Time from Low	t _{LZ}	Figures 7 and 9, C _L = 15pF, S1 closed	300		3000	ns
Driver Disable Time from High	t _{HZ}	Figures 7 and 9, C _L = 15pF, S2 closed	300		3000	ns
Receiver Input to Output	t _{PLH}	Figures 6 and 10, R _{DIFF} = 54Ω, C _{L1} = C _{L2} = 100pF	250		2000	ns
	t _{PHL}		250		2000	
t _{PLH} - t _{PHL} Differential Receiver Skew	t _{SKD}	Figures 6 and 10, R _{DIFF} = 54Ω, C _{L1} = C _{L2} = 100pF		100		ns
Receiver Enable to Output Low	t _{ZL}	Figures 5 and 11, C _R _L = 15pF, S1 closed		20	50	ns
Receiver Enable to Output High	t _{ZH}	Figures 5 and 11, C _R _L = 15pF, S2 closed		20	50	ns
Receiver Disable Time from Low	t _{LZ}	Figures 5 and 11, C _R _L = 15pF, S1 closed		20	50	ns
Receiver Disable Time from High	t _{HZ}	Figures 5 and 11, C _R _L = 15pF, S2 closed		20	50	ns
Maximum Data Rate	f _{MAX}	t _{PLH} , t _{PHL} < 50% of data period	250			kbps
Time to Shutdown	t _{SHDN}	MAX483/MAX487 (Note 5)	50	200	600	ns
Driver Enable from Shutdown to Output High	t _{ZH} (SHDN)	MAX483/MAX487, Figures 7 and 9, C _L = 100pF, S2 closed			2000	ns
Driver Enable from Shutdown to Output Low	t _{ZL} (SHDN)	MAX483/MAX487, Figures 7 and 9, C _L = 100pF, S1 closed			2000	ns
Receiver Enable from Shutdown to Output High	t _{ZH} (SHDN)	MAX483/MAX487, Figures 5 and 11, C _L = 15pF, S2 closed			2500	ns
Receiver Enable from Shutdown to Output Low	t _{ZL} (SHDN)	MAX483/MAX487, Figures 5 and 11, C _L = 15pF, S1 closed			2500	ns

Typical Operating Characteristics

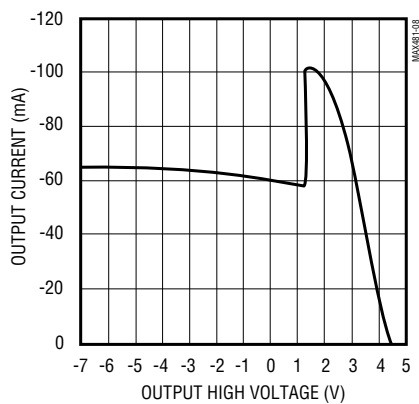
($V_{CC} = 5V$, $T_A = +25^\circ C$, unless otherwise noted.)



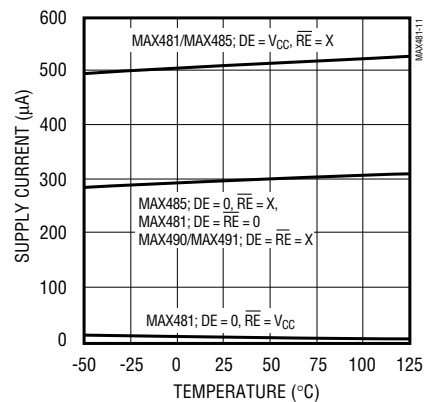
**OUTPUT CURRENT vs.
DRIVER OUTPUT LOW VOLTAGE**



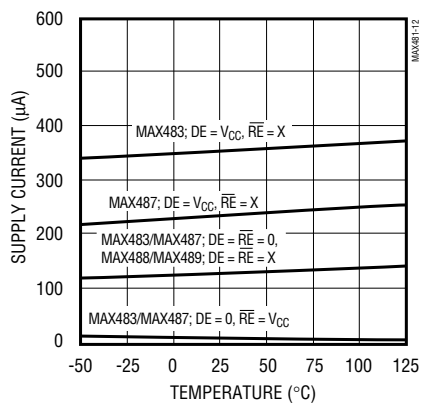
**OUTPUT CURRENT vs.
DRIVER OUTPUT HIGH VOLTAGE**



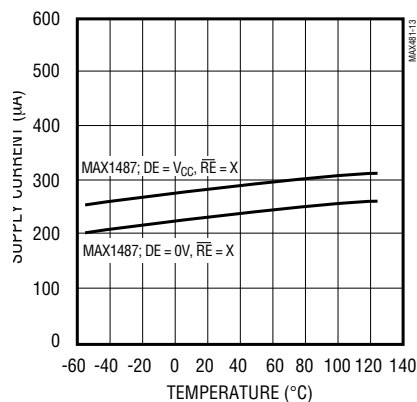
**MAX481/MAX485/MAX490/MAX491
SUPPLY CURRENT vs. TEMPERATURE**



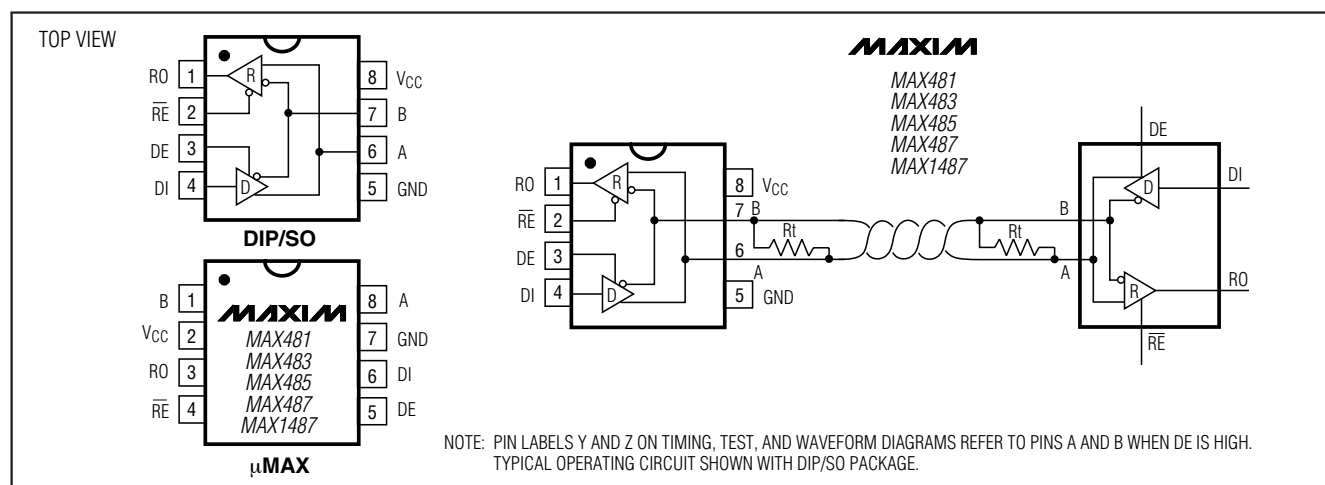
**MAX483/MAX487-MAX489
SUPPLY CURRENT vs. TEMPERATURE**



**MAX1487
SUPPLY CURRENT vs. TEMPERATURE**



PIN					NAME	FUNCTION
MAX481/MAX483/ MAX485/MAX487/ MAX1487		MAX488/ MAX490		MAX489/ MAX491		
DIP/SO	μMAX	DIP/SO	μMAX	DIP/SO		
1	3	2	4	2	RO	Receiver Output: If $A > B$ by 200mV, RO will be high; If $A < B$ by 200mV, RO will be low.
2	4	—	—	3	$\overline{RE}$	Receiver Output Enable. RO is enabled when $\overline{RE}$ is low; RO is high impedance when $\overline{RE}$ is high.
3	5	—	—	4	DE	Driver Output Enable. The driver outputs, Y and Z, are enabled by bringing DE high. They are high impedance when DE is low. If the driver outputs are enabled, the parts function as line drivers. While they are high impedance, they function as line receivers if $\overline{RE}$ is low.
4	6	3	5	5	DI	Driver Input. A low on DI forces output Y low and output Z high. Similarly, a high on DI forces output Y high and output Z low.
5	7	4	6	6, 7	GND	Ground
—	—	5	7	9	Y	Noninverting Driver Output
—	—	6	8	10	Z	Inverting Driver Output
6	8	—	—	—	A	Noninverting Receiver Input and Noninverting Driver Output
—	—	8	2	12	A	Noninverting Receiver Input
7	1	—	—	—	B	Inverting Receiver Input and Inverting Driver Output
—	—	7	1	11	B	Inverting Receiver Input
8	2	1	3	14	V _{CC}	Positive Supply: $4.75V \leq V_{CC} \leq 5.25V$
—	—	—	—	1, 8, 13	N.C.	No Connect—not internally connected



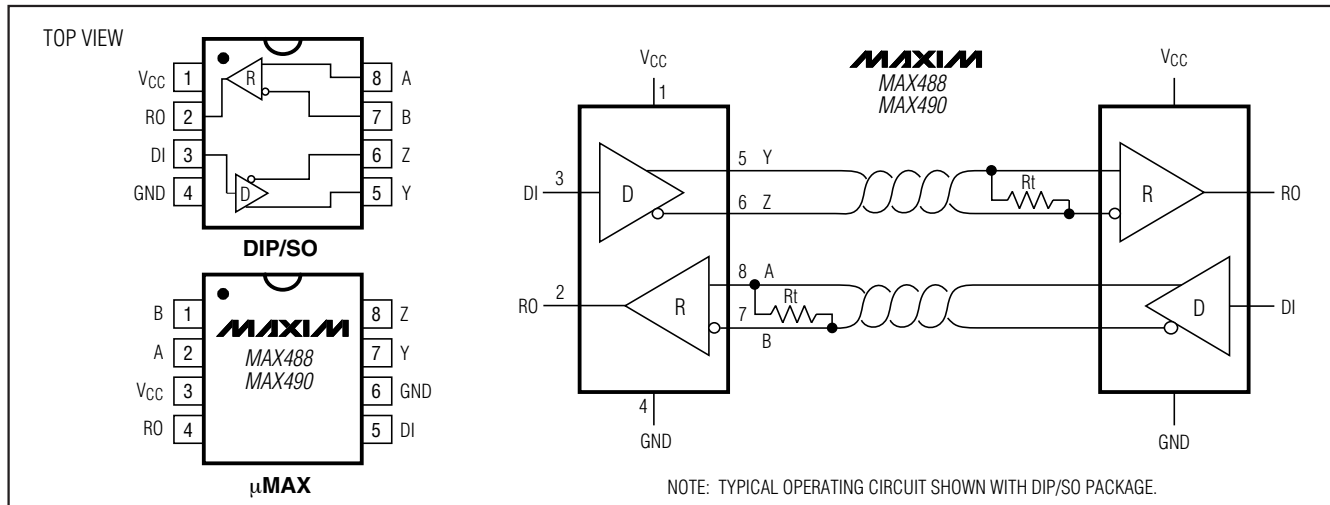
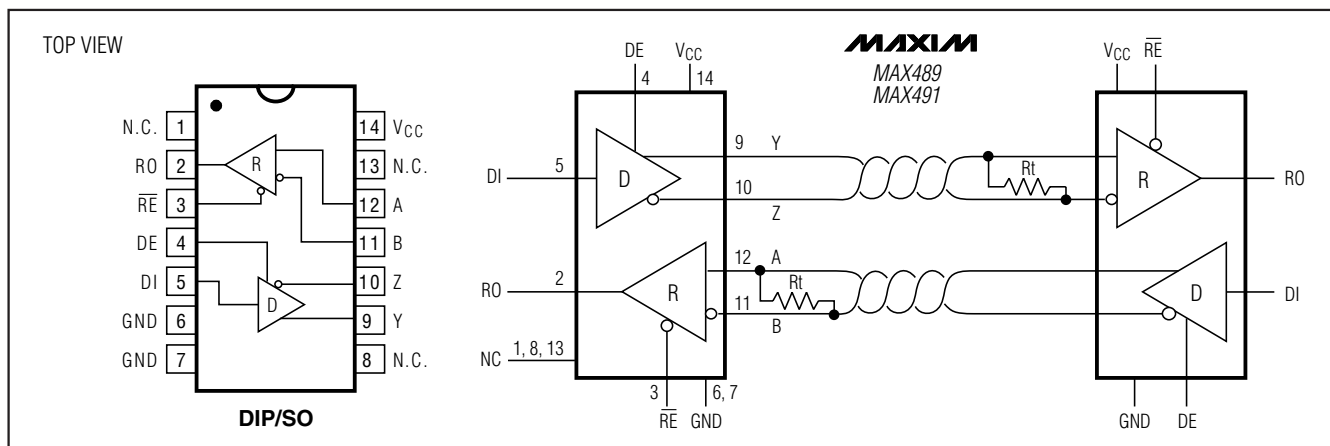


Figure 2. MAX488/MAX490 Pin Configuration and Typical Operating Circuit



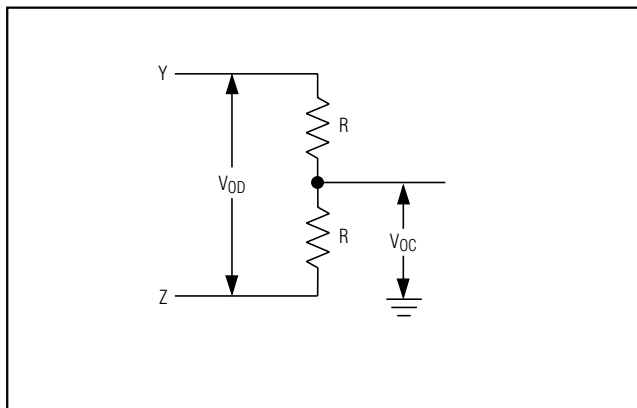


Figure 4. Driver DC Test Load

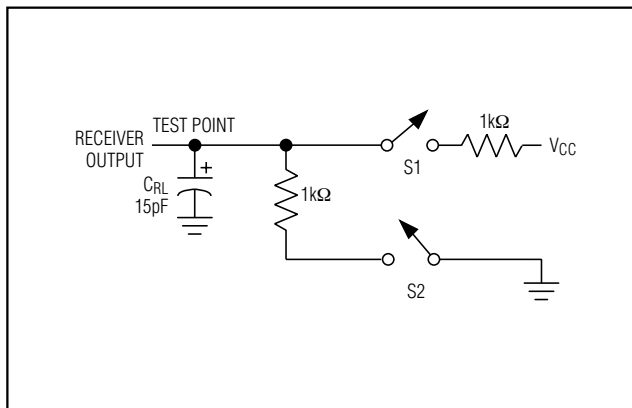
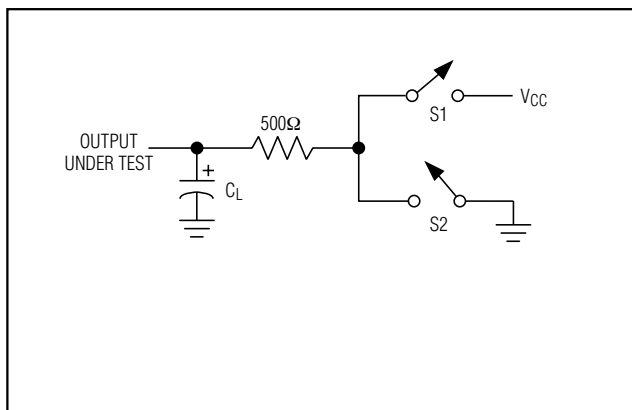
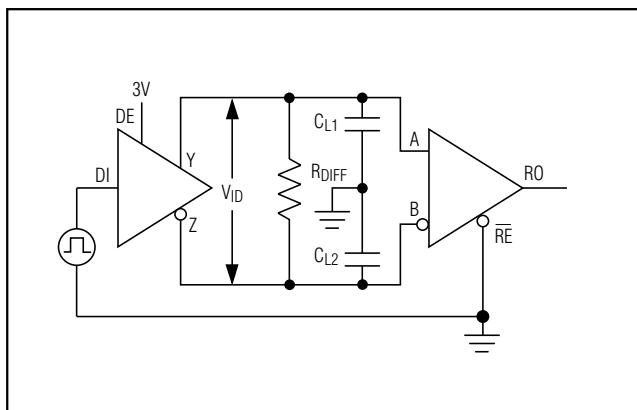


Figure 5. Receiver Timing Test Load



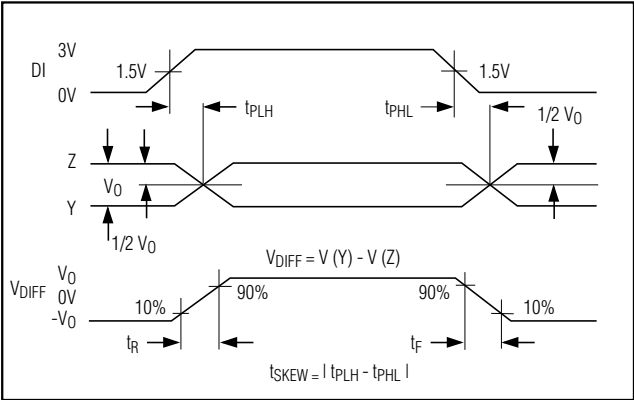


Figure 8. Driver Propagation Delays

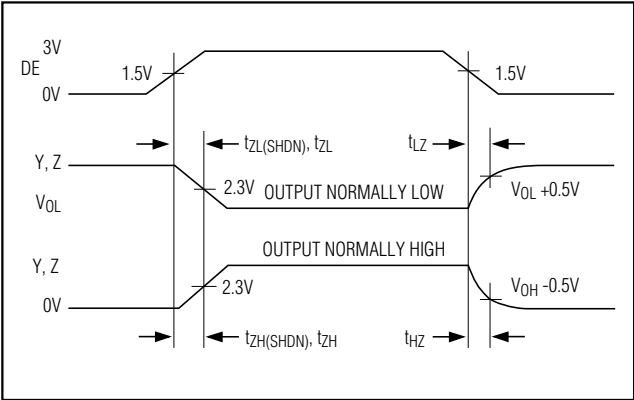


Figure 9. Driver Enable and Disable Times (except MAX488 and MAX490)

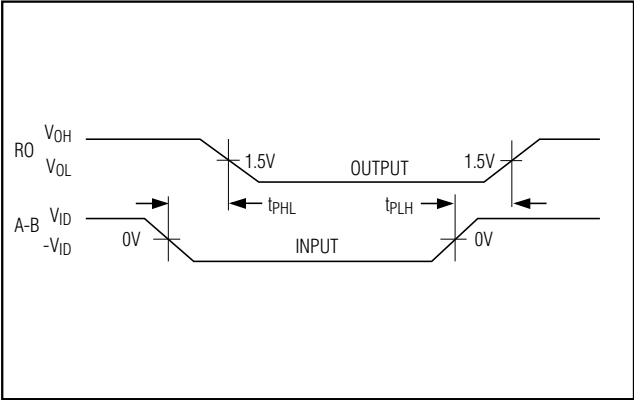


Figure 10. Receiver Propagation Delays

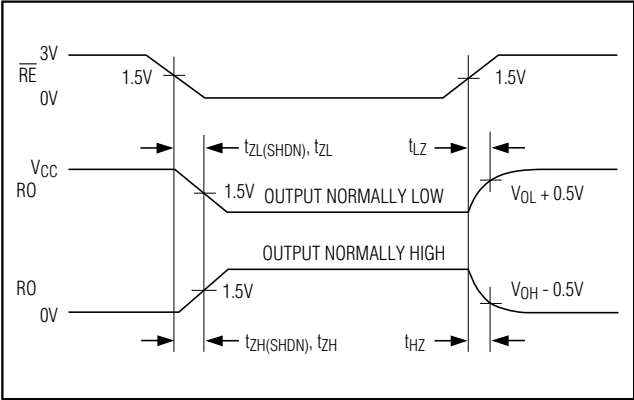


Figure 11. Receiver Enable and Disable Times (except MAX488 and MAX490)

Function Tables (MAX481/MAX483/MAX485/MAX487/MAX1487)

Table 1. Transmitting

INPUTS			OUTPUTS	
RE	DE	DI	Z	Y
X	1	1	0	1
X	1	0	1	0
0	0	X	High-Z	High-Z
1	0	X	High-Z*	High-Z*

Table 2. Receiving

INPUTS			OUTPUT
RE	DE	A-B	RO
0	0	≥ +0.2V	1
0	0	≤ -0.2V	0
0	0	Inputs open	1
1	0	X	High-Z*

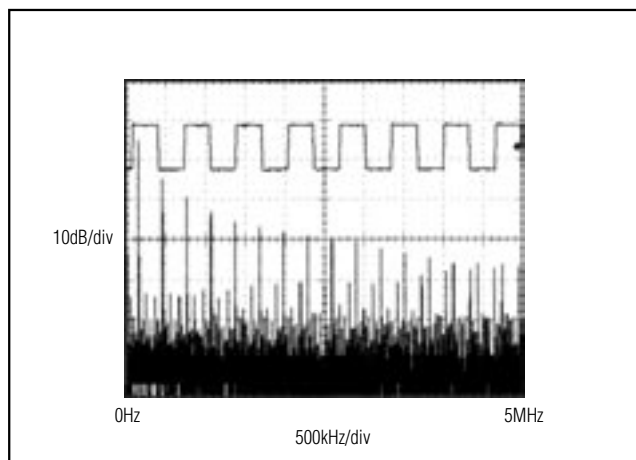


Figure 12. Driver Output Waveform and FFT Plot of MAX481/MAX485/MAX490/MAX491/MAX1487 Transmitting a 150kHz Signal

Low-Power Shutdown Mode (MAX481/MAX483/MAX487)

A low-power shutdown mode is initiated by bringing both $\overline{\text{RE}}$ high and DE low. The devices will not shut down unless both the driver and receiver are disabled. In shutdown, the devices typically draw only 0.1 μA of supply current.

$\overline{\text{RE}}$ and DE may be driven simultaneously; the parts are guaranteed not to enter shutdown if $\overline{\text{RE}}$ is high and DE is low for less than 50ns. If the inputs are in this state for at least 600ns, the parts are guaranteed to enter shutdown.

For the MAX481, MAX483, and MAX487, the t_{ZH} and t_{ZL} enable times assume the part was not in the low-power shutdown state (the MAX485/MAX488–MAX491 and MAX1487 can not be shut down). The $t_{\text{ZH}}(\text{SHDN})$ and $t_{\text{ZL}}(\text{SHDN})$ enable times assume the parts were shut down (see *Electrical Characteristics*).

It takes the drivers and receivers longer to become enabled from the low-power shutdown state ($t_{\text{ZH}}(\text{SHDN})$, $t_{\text{ZL}}(\text{SHDN})$) than from the operating mode (t_{ZH} , t_{ZL}). (The parts are in operating mode if the $\overline{\text{RE}}$, DE inputs equal a logical 0, 1 or 1, 1 or 0, 0.)

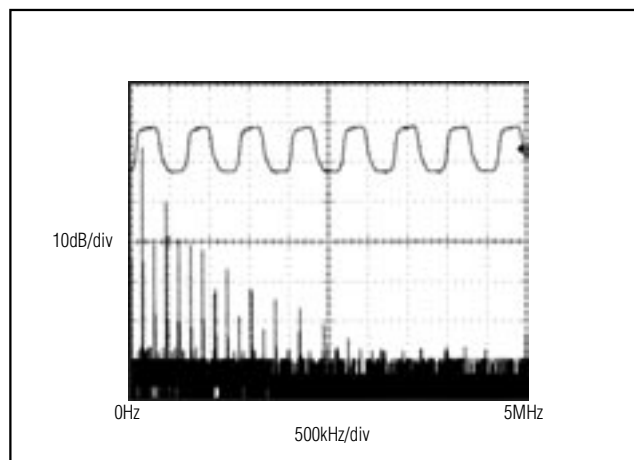


Figure 13. Driver Output Waveform and FFT Plot of MAX483/MAX487–MAX489 Transmitting a 150kHz Signal

Driver Output Protection

Excessive output current and power dissipation caused by faults or by bus contention are prevented by two mechanisms. A foldback current limit on the output stage provides immediate protection against short circuits over the whole common-mode voltage range (see *Typical Operating Characteristics*). In addition, a thermal shutdown circuit forces the driver outputs into a high-impedance state if the die temperature rises excessively.

Propagation Delay

Many digital encoding schemes depend on the difference between the driver and receiver propagation delay times. Typical propagation delays are shown in Figures 15–18 using Figure 14's test circuit.

The difference in receiver delay times, $|t_{\text{PLH}} - t_{\text{PHL}}|$, is typically under 13ns for the MAX481, MAX485, MAX490, MAX491, and MAX1487 and is typically less than 100ns for the MAX483 and MAX487–MAX489.

The driver skew times are typically 5ns (10ns max) for the MAX481, MAX485, MAX490, MAX491, and MAX1487, and are typically 100ns (800ns max) for the MAX483 and MAX487–MAX489.

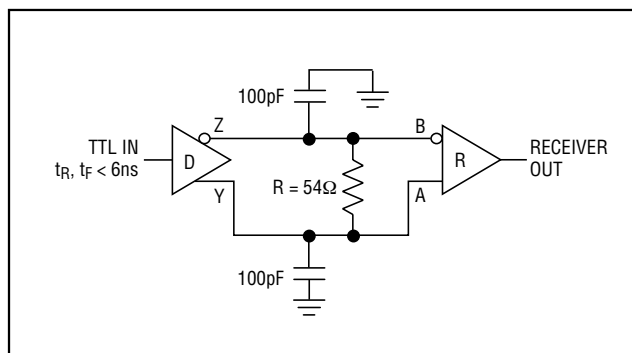


Figure 14. Receiver Propagation Delay Test Circuit

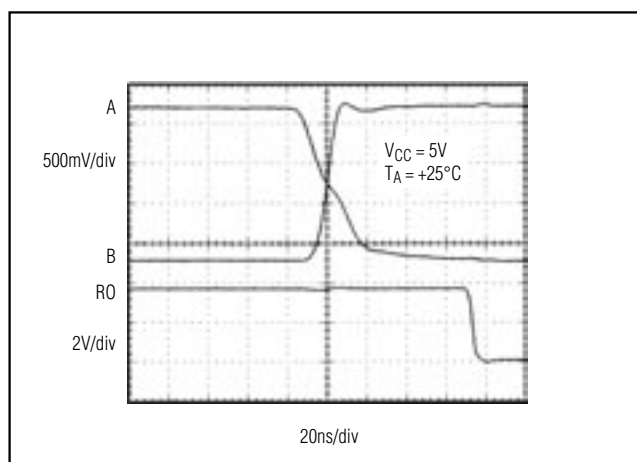


Figure 15. MAX481/MAX485/MAX490/MAX491/MAX1487 Receiver t_{PHL}

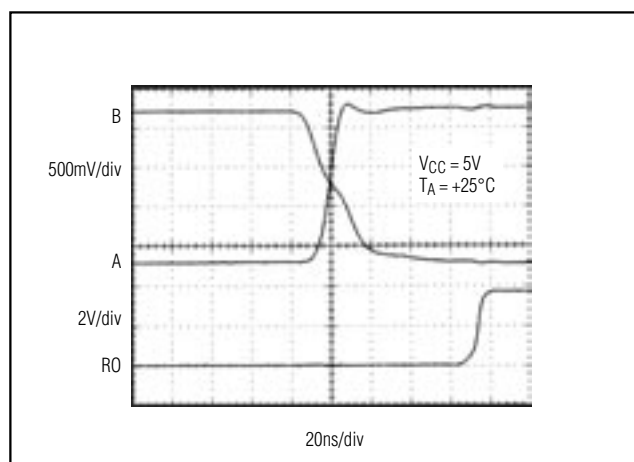
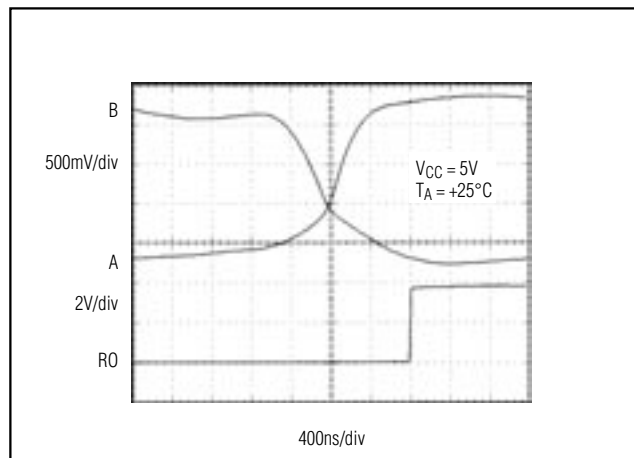
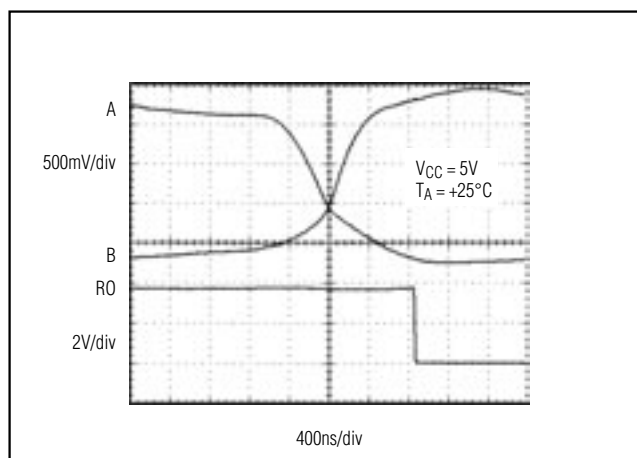


Figure 16. MAX481/MAX485/MAX490/MAX491/MAX1487 Receiver t_{PLH}



Line Length vs. Data Rate

The RS-485/RS-422 standard covers line lengths up to 4000 feet. For line lengths greater than 4000 feet, see Figure 23.

Figures 19 and 20 show the system differential voltage for the parts driving 4000 feet of 26AWG twisted-pair wire at 110kHz into 120Ω loads.

Typical Applications

The MAX481, MAX483, MAX485, MAX487–MAX491, and MAX1487 transceivers are designed for bidirectional data communications on multipoint bus transmission lines.

Figures 21 and 22 show typical network applications circuits. These parts can also be used as line repeaters, with cable lengths longer than 4000 feet, as shown in Figure 23.

To minimize reflections, the line should be terminated at both ends in its characteristic impedance, and stub lengths off the main line should be kept as short as possible. The slew-rate-limited MAX483 and MAX487–MAX489 are more tolerant of imperfect termination.

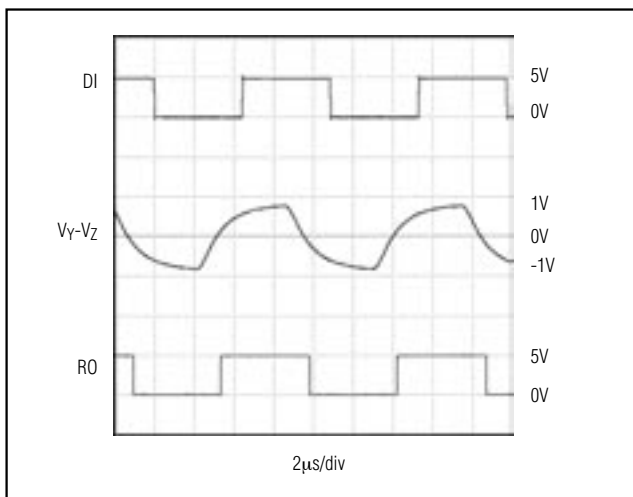


Figure 19. MAX481/MAX485/MAX490/MAX491/MAX1487 System Differential Voltage at 110kHz Driving 4000ft of Cable

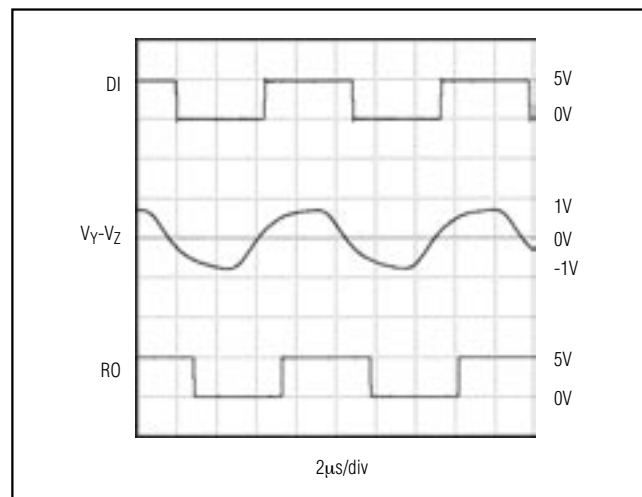
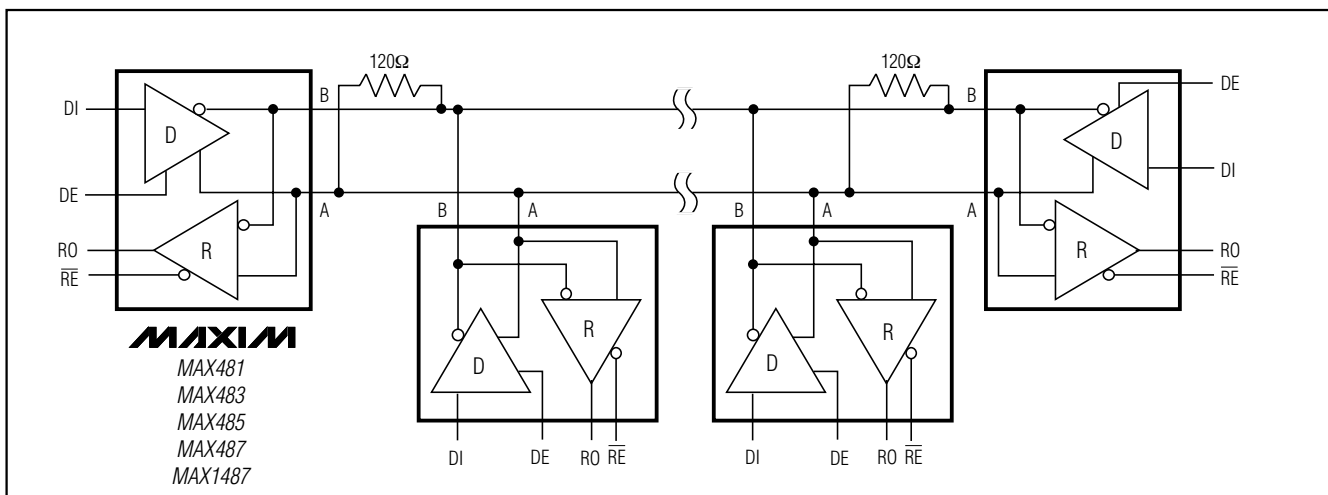


Figure 20. MAX483, MAX487–MAX489 System Differential Voltage at 110kHz Driving 4000ft of Cable



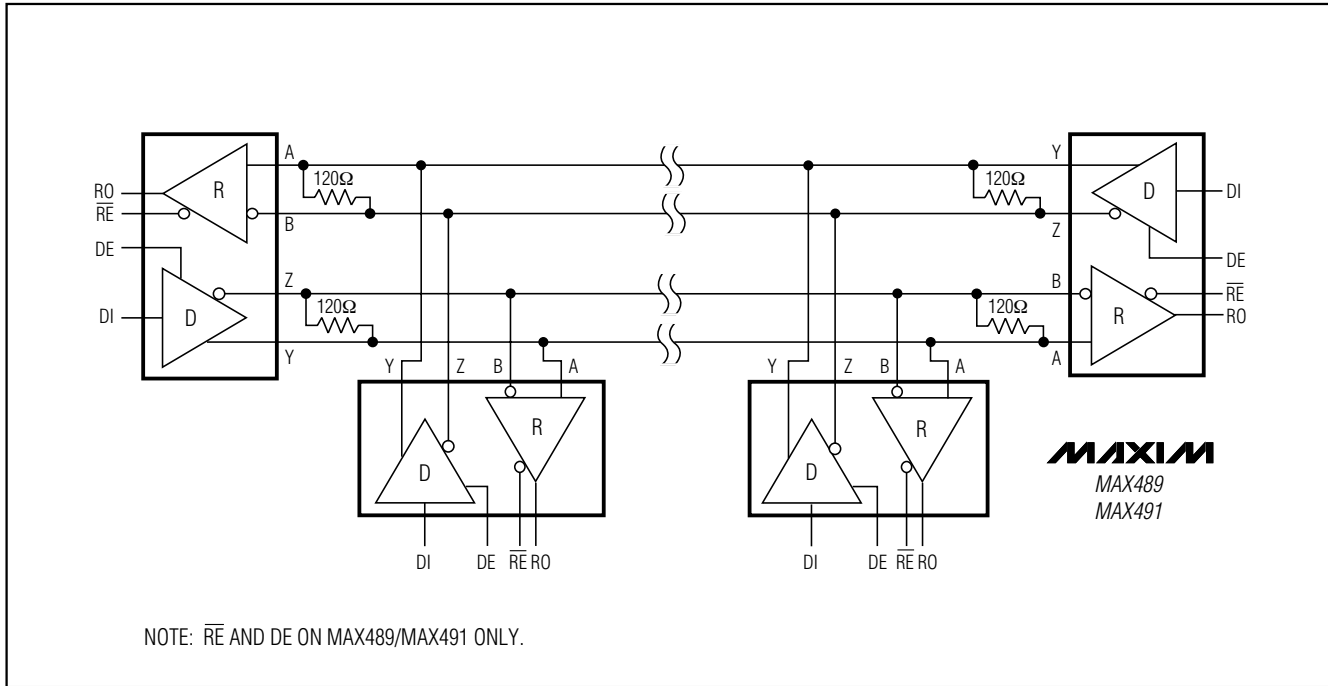


Figure 22. MAX488-MAX491 Full-Duplex RS-485 Network

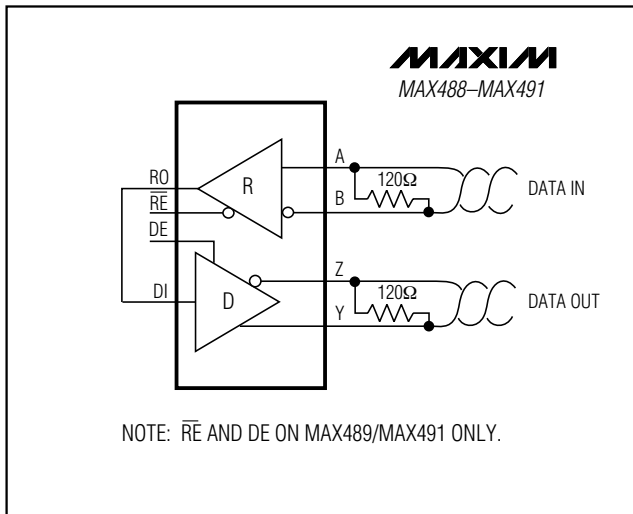


Figure 23. Line Repeater for MAX488-MAX491

Isolated RS-485

For isolated RS-485 applications, see the MAX253 and MAX1480 data sheets.

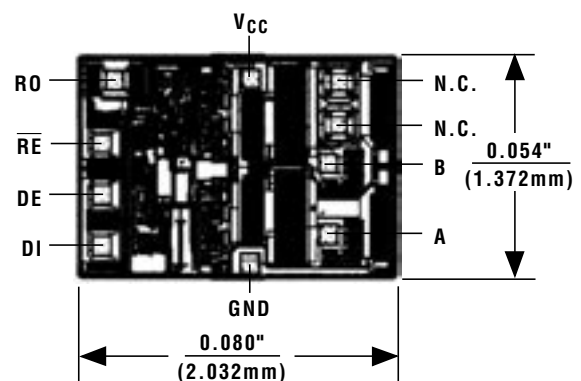
PART	TEMP. RANGE	PIN-PACKAGE
MAX481 CPA	0°C to +70°C	8 Plastic DIP
MAX481CSA	0°C to +70°C	8 SO
MAX481CUA	0°C to +70°C	8 μ MAX
MAX481C/D	0°C to +70°C	Dice*
MAX481EPA	-40°C to +85°C	8 Plastic DIP
MAX481ESA	-40°C to +85°C	8 SO
MAX481MJA	-55°C to +125°C	8 CERDIP
MAX483 CPA	0°C to +70°C	8 Plastic DIP
MAX483CSA	0°C to +70°C	8 SO
MAX483CUA	0°C to +70°C	8 μ MAX
MAX483C/D	0°C to +70°C	Dice*
MAX483EPA	-40°C to +85°C	8 Plastic DIP
MAX483ESA	-40°C to +85°C	8 SO
MAX483MJA	-55°C to +125°C	8 CERDIP
MAX485 CPA	0°C to +70°C	8 Plastic DIP
MAX485CSA	0°C to +70°C	8 SO
MAX485CUA	0°C to +70°C	8 μ MAX
MAX485C/D	0°C to +70°C	Dice*
MAX485EPA	-40°C to +85°C	8 Plastic DIP
MAX485ESA	-40°C to +85°C	8 SO
MAX485MJA	-55°C to +125°C	8 CERDIP
MAX487 CPA	0°C to +70°C	8 Plastic DIP
MAX487CSA	0°C to +70°C	8 SO
MAX487CUA	0°C to +70°C	8 μ MAX
MAX487C/D	0°C to +70°C	Dice*
MAX487EPA	-40°C to +85°C	8 Plastic DIP
MAX487ESA	-40°C to +85°C	8 SO
MAX487MJA	-55°C to +125°C	8 CERDIP
MAX488 CPA	0°C to +70°C	8 Plastic DIP
MAX488CSA	0°C to +70°C	8 SO
MAX488CUA	0°C to +70°C	8 μ MAX
MAX488C/D	0°C to +70°C	Dice*
MAX488EPA	-40°C to +85°C	8 Plastic DIP
MAX488ESA	-40°C to +85°C	8 SO
MAX488MJA	-55°C to +125°C	8 CERDIP
MAX489 CPD	0°C to +70°C	14 Plastic DIP
MAX489CSD	0°C to +70°C	14 SO
MAX489C/D	0°C to +70°C	Dice*
MAX489EPD	-40°C to +85°C	14 Plastic DIP
MAX489ESD	-40°C to +85°C	14 SO
MAX489MJD	-55°C to +125°C	14 CERDIP

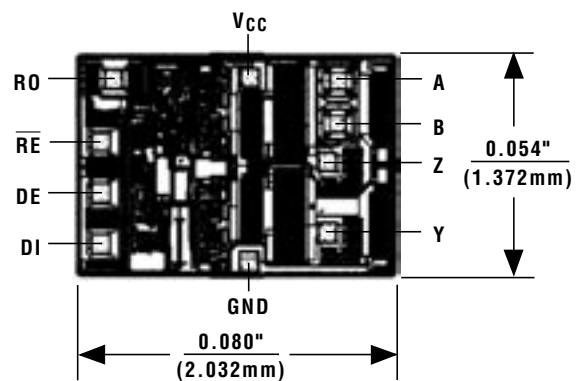
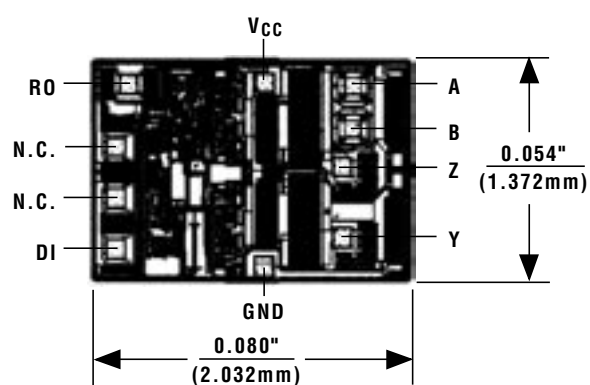
PART	TEMP. RANGE	PIN-PACKAGE
MAX490 CPA	0°C to +70°C	8 Plastic DIP
MAX490CSA	0°C to +70°C	8 SO
MAX490CUA	0°C to +70°C	8 μ MAX
MAX490C/D	0°C to +70°C	Dice*
MAX490EPA	-40°C to +85°C	8 Plastic DIP
MAX490ESA	-40°C to +85°C	8 SO
MAX490MJA	-55°C to +125°C	8 CERDIP
MAX491 CPD	0°C to +70°C	14 Plastic DIP
MAX491CSD	0°C to +70°C	14 SO
MAX491C/D	0°C to +70°C	Dice*
MAX491EPD	-40°C to +85°C	14 Plastic DIP
MAX491ESD	-40°C to +85°C	14 SO
MAX491MJD	-55°C to +125°C	14 CERDIP
MAX1487 CPA	0°C to +70°C	8 Plastic DIP
MAX1487CSA	0°C to +70°C	8 SO
MAX1487CUA	0°C to +70°C	8 μ MAX
MAX1487C/D	0°C to +70°C	Dice*
MAX1487EPA	-40°C to +85°C	8 Plastic DIP
MAX1487ESA	-40°C to +85°C	8 SO
MAX1487MJA	-55°C to +125°C	8 CERDIP

* Contact factory for dice specifications.

Chip Topographies

MAX481/MAX483/MAX485/MAX487/MAX1487

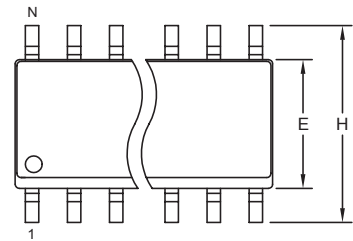




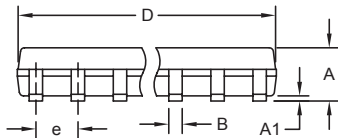
TRANSISTOR COUNT: 248
SUBSTRATE CONNECTED TO GND

Package Information

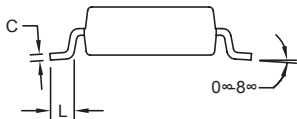
(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to www.maxim-ic.com/packages.)



TOP VIEW



FRONT VIEW



SIDE VIEW

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.053	0.069	1.35	1.75
A1	0.004	0.010	0.10	0.25
B	0.014	0.019	0.35	0.49
C	0.007	0.010	0.19	0.25
e	0.050 BSC		1.27 BSC	
E	0.150	0.157	3.80	4.00
H	0.228	0.244	5.80	6.20
L	0.016	0.050	0.40	1.27

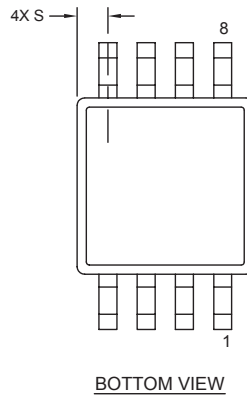
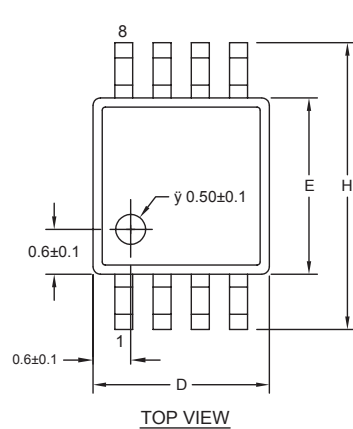
VARIATIONS:

DIM	INCHES		MILLIMETERS		N	MS012
	MIN	MAX	MIN	MAX		
D	0.189	0.197	4.80	5.00	8	AA
D	0.337	0.344	8.55	8.75	14	AB
D	0.386	0.394	9.80	10.00	16	AC

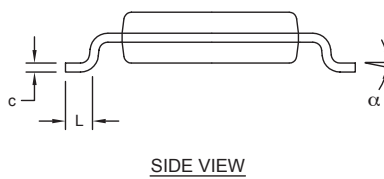
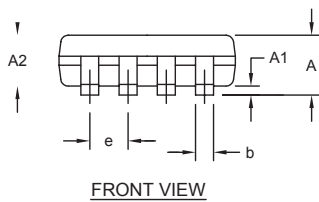
1. D&E DO NOT INCLUDE MOLD FLASH.
2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED 0.15mm (.006").
3. LEADS TO BE COPLANAR WITHIN 0.10mm (.004").
4. CONTROLLING DIMENSION: MILLIMETERS.
5. MEETS JEDEC MS012.
6. N = NUMBER OF PINS.

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to www.maxim-ic.com/packages.)



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	-	0.043	-	1.10
A1	0.002	0.006	0.05	0.15
A2	0.030	0.037	0.75	0.95
b	0.010	0.014	0.25	0.36
c	0.005	0.007	0.13	0.18
D	0.116	0.120	2.95	3.05
e	0.0256 BSC		0.65 BSC	
E	0.116	0.120	2.95	3.05
H	0.188	0.198	4.78	5.03
L	0.016	0.026	0.41	0.66
α	0°	6°	0°	6°
S	0.0207 BSC		0.5250 BSC	

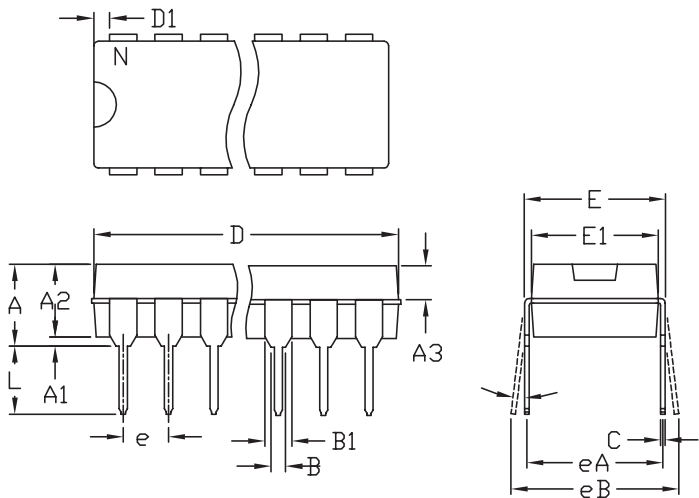


NOTES:

1. D&E DO NOT INCLUDE MOLD FLASH.
2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED 0.15MM (.006").
3. CONTROLLING DIMENSION: MILLIMETERS.
4. MEETS JEDEC MO-187C-AA.

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to www.maxim-ic.com/packages.)



	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
-1	0.015	---	0.38	---
A2	0.125	0.175	3.18	4.45
A3	0.055	0.080	1.40	2.03
B	0.015	0.022	0.381	0.56
B1	0.045	0.065	1.14	1.65
C	0.008	0.014	0.2	0.355
D1	0.005	0.080	0.13	2.03
E	0.300	0.325	7.62	8.26
E1	0.240	0.310	6.10	7.87
e	0.100	BSC.	2.54	BSC.
eA	0.300	BSC.	7.62	BSC.
eB	0.400	BSC.	10.16	BSC.
L	0.115	0.150	2.921	3.81

	INCHES		MILLIMETERS		N	MS001
	MIN	MAX	MIN	MAX		
D	0.348	0.390	8.84	9.91	8	AB
D	0.735	0.765	18.67	19.43	14	AC
D	0.745	0.765	18.92	19.43	16	AA
D	0.885	0.915	22.48	23.24	18	AD
D	1.015	1.045	25.78	26.54	20	AE
D	1.14	1.265	28.96	32.13	24	AF
D	1.360	1.380	34.54	35.05	28	*5

- NOTES:
1. D&E DO NOT INCLUDE MOLD FLASH
 2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED .15mm (.006")
 3. CONTROLLING DIMENSION: MILLIMETER
 4. MEETS JEDEC MS001-XX AS SHOWN IN ABOVE TABLE
 5. SIMILAR TO JEDEC MO-058AB
 6. N = NUMBER OF PINS